

Material Content Data Sheet

RoHS | Halogen-Free

Sales Product Name	ISC0703NLS	**Issued**	17. May 2021
MA#	MA005423139		
Package	PG-TDSON-8-45	**Weight***	117.81 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	0.294	0.25	0.25	2491	2491
leadframe	inorganic material	phosphorus	7723-14-0	0.011	0.01		96	
	non noble metal	iron	7439-89-6	0.038	0.03		321	
	non noble metal	copper	7440-50-8	37.762	32.06	32.10	320517	320934
wire	noble metal	gold	7440-57-5	0.047	0.04	0.04	398	398
encapsulation	organic material	carbon black	1333-86-4	0.088	0.07		745	
	plastics	epoxy resin	-	6.937	5.89		58881	
	inorganic material	silicondioxide	60676-86-0	36.880	31.30	37.26	313038	372664
leadfinish	non noble metal	tin	7440-31-5	1.452	1.23	1.23	12322	12322
plating	noble metal	silver	7440-22-4	0.166	0.14	0.14	1405	1405
solder	non noble metal	tin	7440-31-5	0.010	0.01		82	
	noble metal	silver	7440-22-4	0.012	0.01		103	
	non noble metal	lead	7439-92-1	0.464	0.39	0.41	3936	4121
heat sink clip	inorganic material	phosphorus	7723-14-0	0.007	0.01		57	
	non noble metal	iron	7439-89-6	0.022	0.02		189	
	non noble metal	copper	7440-50-8	22.292	18.92	18.95	189210	189456
heatspreader	inorganic material	phosphorus	7723-14-0	0.003			29	
	non noble metal	iron	7439-89-6	0.011	0.01		96	
	non noble metal	copper	7440-50-8	11.320	9.61	9.62	96084	96209
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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